TOSHIBA Diode Silicon Epitaxial Planar Type

# 1SS387CT

Ultra High Speed Switching Application

- Small package
- Low forward voltage:  $V_{F(3)} = 0.98 V (typ.)$
- Fast reverse recovery time: t<sub>rr</sub> = 1.6 ns (typ.)
- Small total capacitance:  $C_T = 0.5 \text{ pF}$  (typ.)

### Unit: mm 0.6±0.05 0.05±0.03 CATHODE MARK 0.25±0 1.0±0.05 65 0.25+0.030.38 +0.02 0.05±0.03 0 CST2 JEDEC JEITA 1-1P1A TOSHIBA

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Maximum (peak) reverse Voltage	V <sub>RM</sub>	85	V	
Reverse voltage	V <sub>R</sub>	80	V	
Maximum (peak) forward current	I <sub>FM</sub>	200	mA	
Average forward current	Ι <sub>Ο</sub>	100	mA	
Surge current (10 ms)	I <sub>FSM</sub>	1	А	
Power dissipation	P *	150	mW	
Junction temperature	Тj	150	°C	
Storage temperature	T <sub>stg</sub>	−55 to 150	°C	



\*: Mounted on a glass epoxy circuit board of 20 mm × 20 mm, pad dimension of 4 mm × 4 mm.

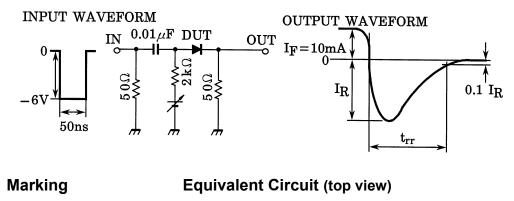
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit	
Forward voltage	V <sub>F (1)</sub>	_	I <sub>F</sub> = 1 mA		0.62		v	
	V <sub>F (2)</sub>	_	I <sub>F</sub> = 10 mA	_	0.75	_		
	V <sub>F (3)</sub>	_	I <sub>F</sub> = 100 mA	_	0.98	1.20		
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 30 V	_	—	0.1		
	I <sub>R (2)</sub>	_	V <sub>R</sub> = 80 V	_	—	0.5	μA	
Total capacitance	CT	—	V <sub>R</sub> = 0 V, f = 1 MHz	_	0.5	_	pF	
Reverse recovery time	t <sub>rr</sub>	_	I <sub>F</sub> = 10 mA, Fig.1		1.6		ns	

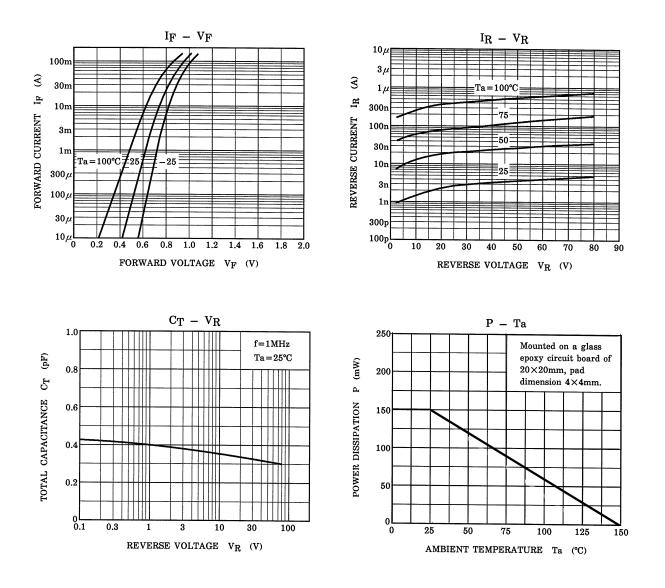
#### Fig.1 Reverse Recovery Time (trr) Test Circuit







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